



**SPECIFICATION
FOR
LCD MODULE**

MODULE NO: AFK480234A0-2.36N6NTN

REVISION NO: V01

Customer's Approval:

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	SIGNATURE	DATE
PREPARED BY (RD ENGINEER)		
CHECKED BY		
APPROVED BY		

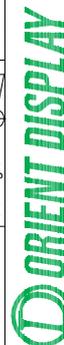
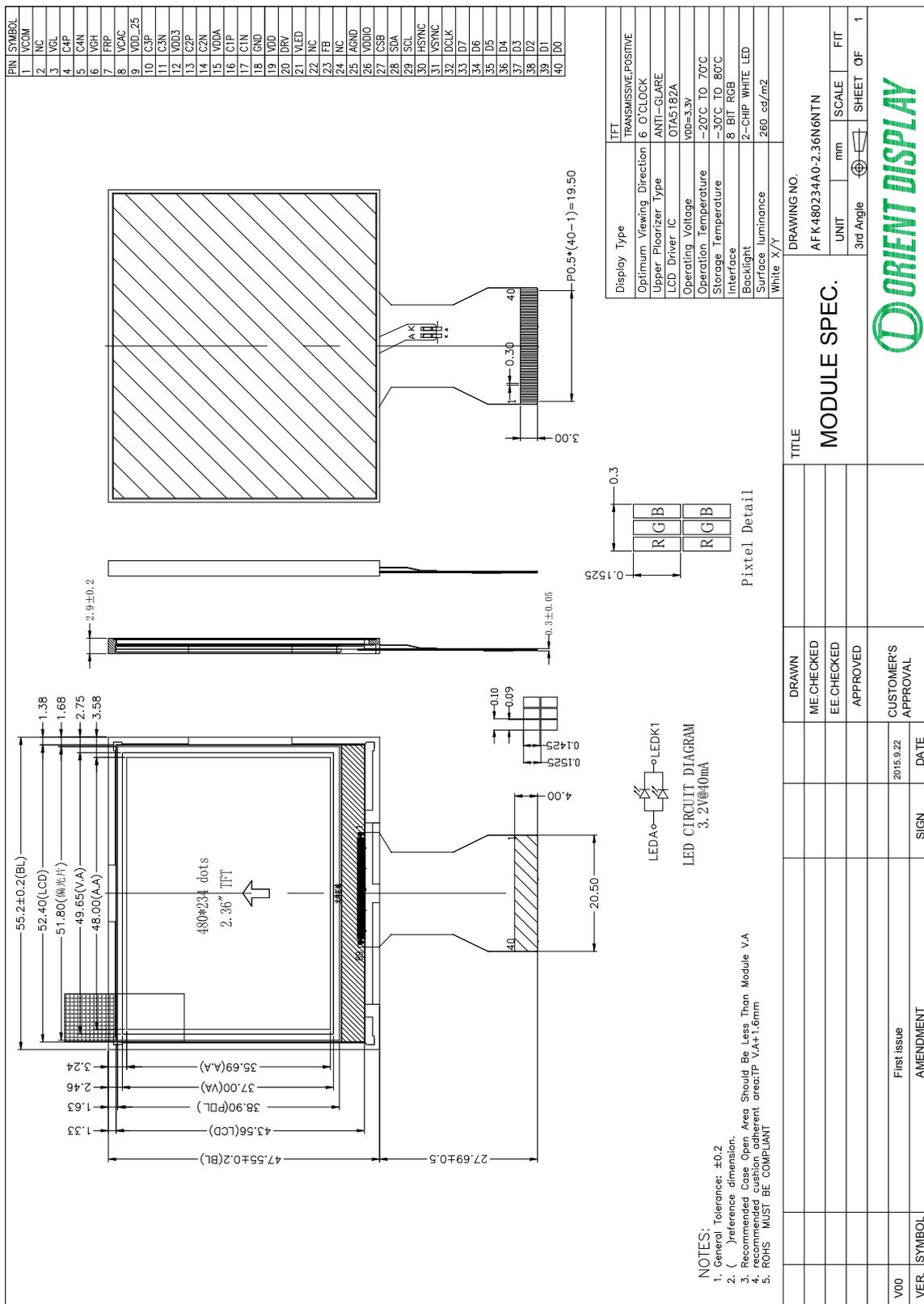
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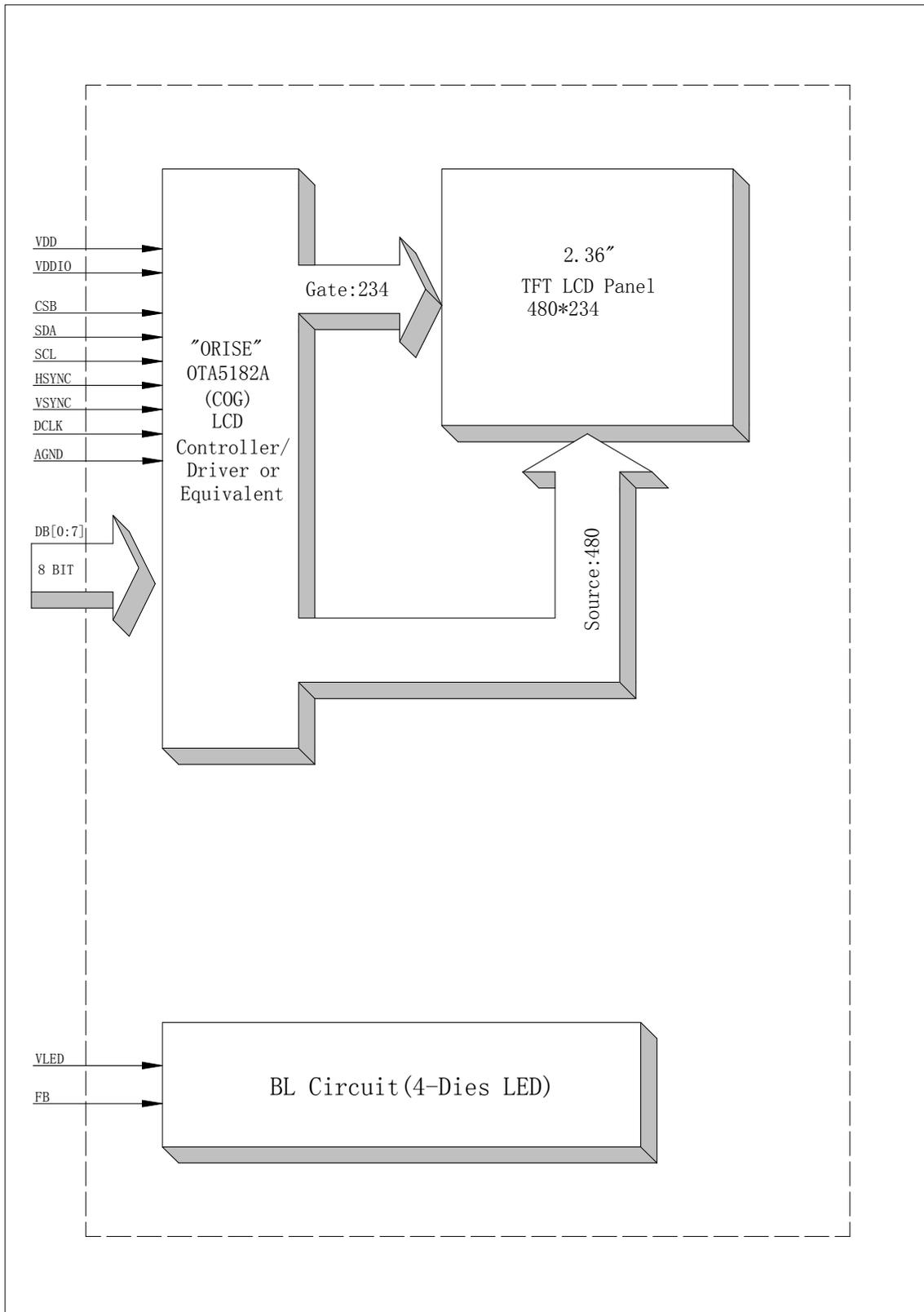
1. General Specification

Item	Contents	Unit
LCD TYPE	TFT/TRANSMISSIVE	
MODULE SIZE (W*H*T)	55.20*47.55*2.90	MM
ACTIVE SIZE (W*H)	48.00*35.69	MM
PIXEL PITCH (W*H)	0.1*0.1525	MM
NUMBER OF DOTS	480*234	
DIVER IC	OTA5182A	
INTERFACE TYPE	8 BIT RGB	
TOP POLARIZER TYPE	ANTI-GLARE	
RECOMMEND VIEWING DIRECTION	6	O'CLOCK
GRAY SCALE INVERSION DIRECTION	12	O'CLOCK
COLORS	65K	
BACKLIGHT TYPE	2-DIES WHITE LED	
TOUCH PANEL TYPE	WITHOUT	

2. Mechanical Drawing



3. Block Diagram



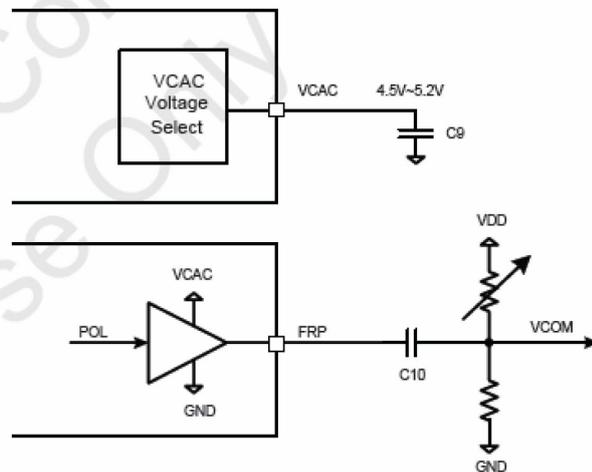
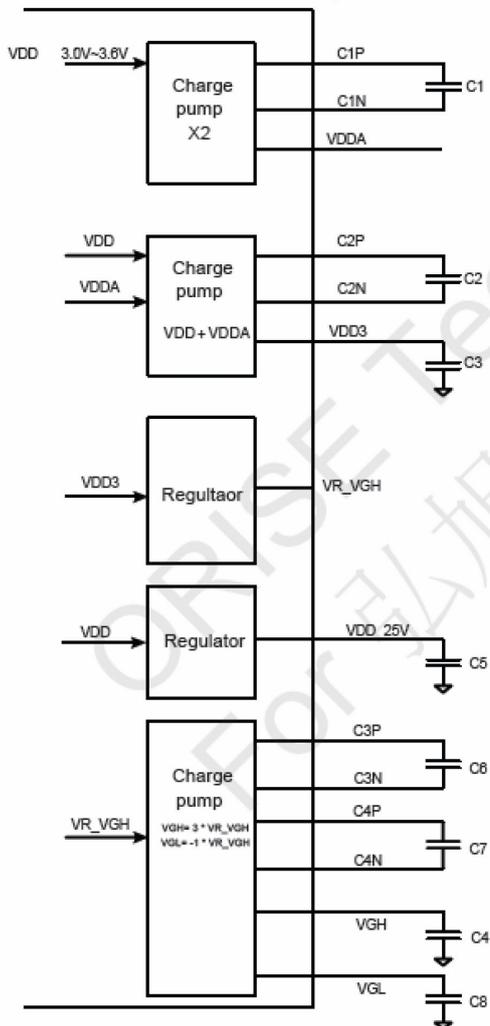
4. Interface Pin Function

Pin No.	Symbol	Description
1	VCOM	Common
2	NC	No Connect
3	VGL	Power supply for gate off voltage.
4	C4P	Pins to connect capacitance for power circuitry.
5	C4N	Pins to connect capacitance for power circuitry.
6	VGH	Power supply for gate on voltage.
7	FRP	Frame polarity output for VCOM.
8	VCAC	Define the amplitude of the VCOM wing.
9	VDD_25V	Intermediate voltage for charge Pump. Please connect the capacitor between VDD_25V and GND.
10	C3P	Pins to connect capacitance for power circuitry.
11	C3N	Pins to connect capacitance for power circuitry.
12	VDD3	Charge-pump circuit reference voltage. Please connect the capacitor between VDD3 and GND.
13	C2P	Pins to connect capacitance for power circuitry.
14	C2N	Pins to connect capacitance for power circuitry.
15	VDDA	Power supply voltage of source driver liquid crystal drives circuit. Please connect the capacitor between VDDA and GND.
16	C1P	Pins to connect capacitance for power circuitry.
17	C1N	Pins to connect capacitance for power circuitry.
18	GND	Power ground
19	VDD	Power supply for analog circuit blocks (3.0~ 3.6 V).
20	DRV	Gate signal for the power transistor of the boost converter.
21	VLED	Supply voltage for LED backlight.
22	NC	No Connect
23	FB	Main boost regulator feedback input.
24	NC	No Connect
25	AGND	Power ground
26	VDDIO	Power supply for interface logic circuits (1.8 ~ 3.6V).
27	CSB	Serial communication chip select (“Low” enable).
28	SDA	Serial communication data input.
29	SCL	Serial communication clock input.
30	HSYNC	Line synchronizing signal for RGB interface operation.
31	VSYNC	Frame synchronizing signal for RGB interface operation.
32	DCLK	Dot clock signal for RGB interface operation.
33~40	D7~D0	Data Input

NOTE: THE CIRCUIT ARE FOR REFERENCE

Note1: VCOM=+5.0 Vp-p.(Typ.)

Note2: The external capacitor is required on those pins as following.



- Note: (1) Value of wiring resistance at pins except VDD, GND, C1P~C4N must be <7 ohm
 (2) Suggestion Capacitors value and types

Capacitor no.	Withstanding voltage(V)	CAP (uF)	Cap. Type
C1,C5,C9,C10	10	1 to 4.7	X5R/Y5V
C2,C3,C6,C7	16	1 to 4.7	X5R/Y5V
C4	25	1 to 4.7	Only X5R
		2.2 to 4.7	X5R/Y5V
C8	25	0.47 to 4.7	X5R/Y5V

Note3: VDD, VDDIO=+3.3V (Typ.)

Note4: Outputs the control signal of switching regulator for LED. Duty cycle varies according to FB input voltage

Note5: Feedback signal of switching signal for LED. It controls DRV output duty cycle with 0.6V input level sense.

Note6: Horizontal sync signal, it is a "L" active signal.

Note7: Vertical sync signal, it is a "Low" active signal.

Note8: Dot clock signal for RGB interface, timing for data loading defined at rising edge.

5. Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit
Supply voltage for analog	VDD	-0.3	4.6	V
Supply voltage for logic	VDDIO	-0.3	4.6	V
Supply current (One LED)	I _{LED}		30	mA
Operating temperature	T _{OP}	-20	+70	°C
Storage temperature	T _{ST}	-30	+80	°C

Note: The absolute maximum rating values of this product are not allowed to be exceeded at any times. Should a module be used with any of the absolute maximum ratings exceeded, the characteristics of the module may not be recovered, or in an extreme case, the module may be permanently destroyed.

6. Electrical Characteristics

6.1 Input Power

Item	Symbol	Min	Typ.	Max	Unit	Applicable terminal
Supply Voltage for Analog	VDD	2.5	2.8	3.3	V	
Supply Voltage for Logic	VDDIO	1.65	1.8/2.8	3.3	V	
Input Voltage	V _{IL}	GND	-	0.3VDDIO	V	
	V _{IH}	0.8 VDDIO	-	VDDIO		
Input leakage Current	I _{LKG}	-1		1	μA	

6.2 Backlight Driving Conditions

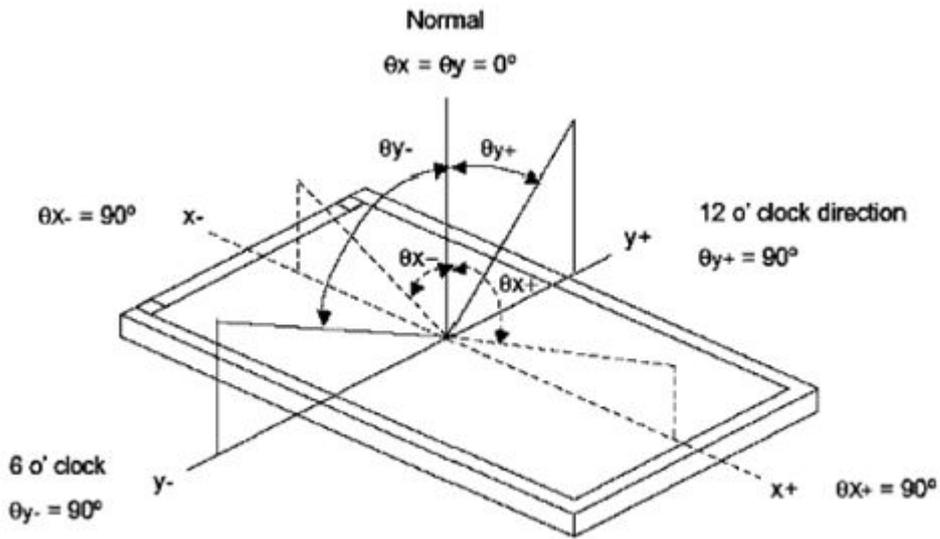
Item	Symbol	Value			Unit	Remark
		Min.	Typ.	Max.		
Voltage for LED Backlight	V _F	-	3.2	-	V	I _L =40mA
Current for LED Backlight	I _L		40	-	mA	
Power Consumption	P		0.128		W	
LED Life Time		30,000			Hr	Note

Note: Brightness to be decreased to 50% of the initial value at ambient temperature TA=25°C

7. Optical Characteristics

ITEM	SYMBOL	CONDITIONS	SPECIFICATIONS			UNIT	NOTE
			MIN	TYP.	MAX		
Luminance	L	$I_L = 30\text{mA}$		260		Cd/m^2	
Contrast Ratio	CR	$\theta = 0^\circ$	250	250			
Response Time	T_{ON}	25°C		50	70	ms	
	T_{OFF}						
CIE Color Coordinate	Red	X_R	Viewing normal angle				
		Y_R					
	Green	X_G					
		Y_G					
	Blue	X_B					
		Y_B					
	White	X_W			0.294		
		Y_W			0.334		
Viewing Angle	Hor.	θ_{X+}	$\text{CR} \geq 10$	45	45	Degree	
		θ_{X-}		45	45		
	Ver.	θ_{Y+}		45	45		
		θ_{Y-}		10	15		
Uniformity	Un		80			%	

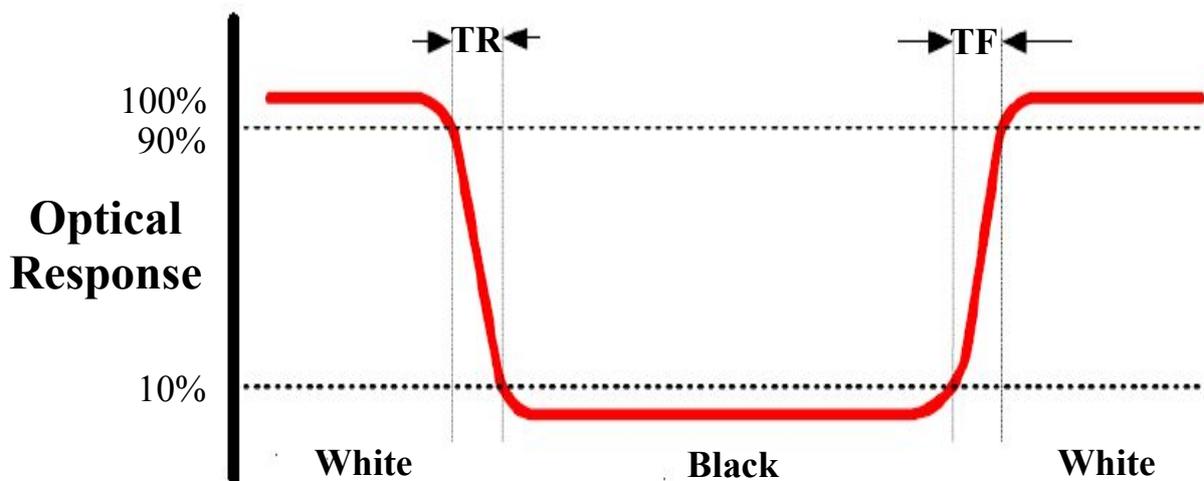
Note 1: Definition of Viewing Angle θ_x and θ_y :



Note 2: Definition of contrast ratio CR:

$$CR = \frac{\text{Luminance of white state}}{\text{Luminance of black state}}$$

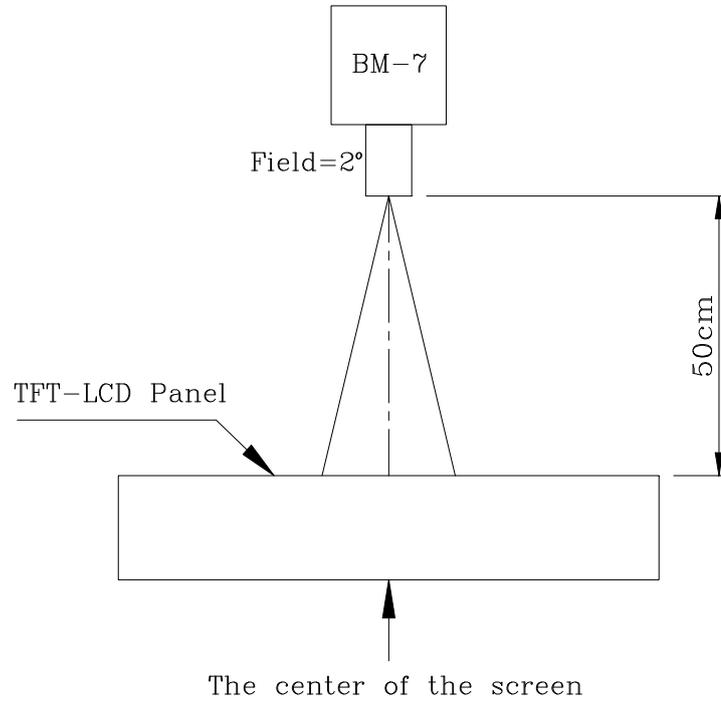
Note 3: Definition of Response Time (T_r, T_f)



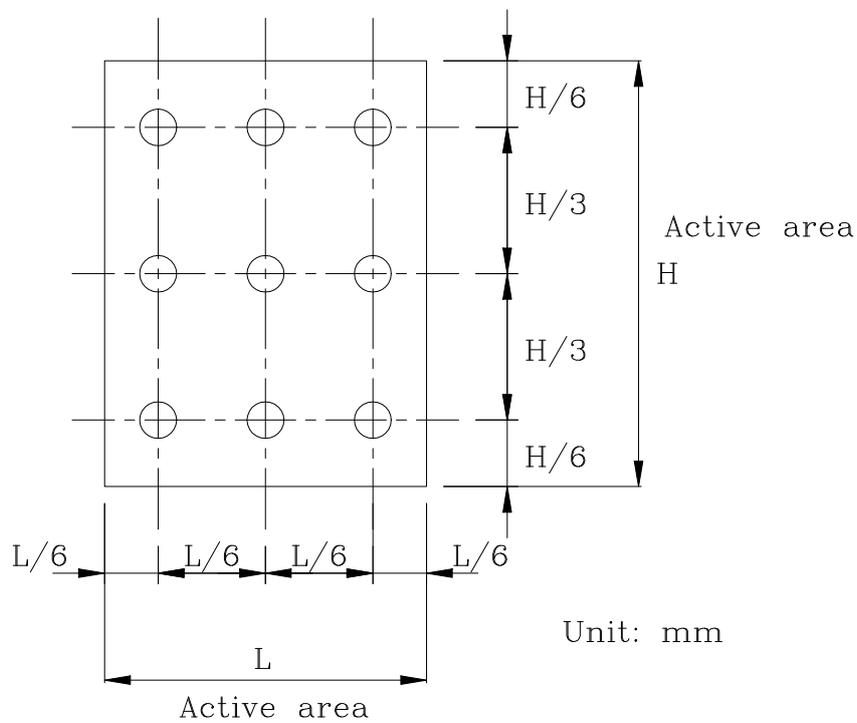
Note 4: Definition of Luminance

①The Brightness Test Equipment Setup

Field=2° (As measuring “black” image, field=2° is the best testing condition)

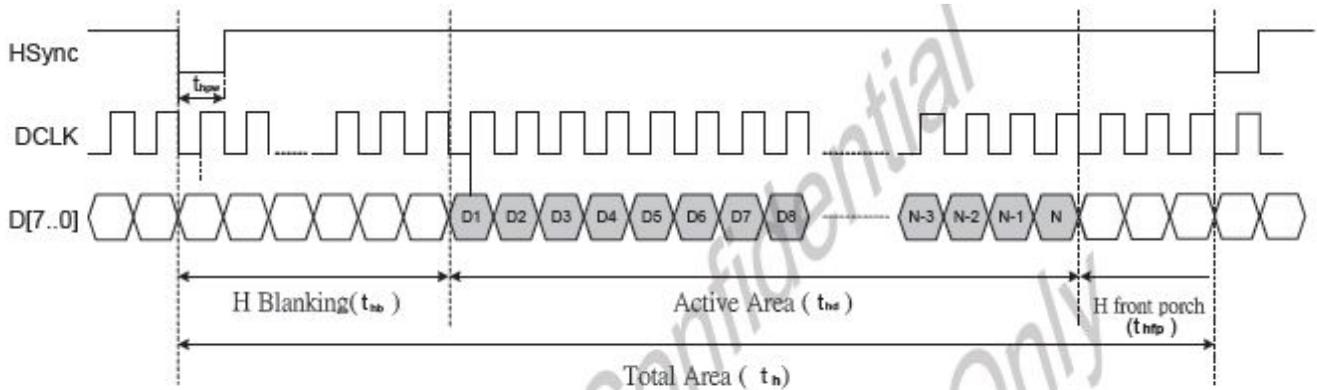


②The Brightness Test Point Setup



8. Timing Characteristics

8.1 Horizon input timing



6.14.1. Raw Data

Parameter	Symbol	Value			Unit
Horizontal display area	t_{hd}	480			DCLK
DCLK frequency	f_{clk}	Min.	Typ.	Max	Mhz
		8.1	9.7	11.3	
1 Horizontal Line	t_h	617			DCLK
HSYNC pulse width	t_{hpw}	Min.	1		
		Typ.	1		
		Max.	96		
HSYNC blanking	t_{hb}	84	100	115	
HSYNC front porch	t_{hfp}	53	37	22	

8.2 Serial RGB mode

NTSC

Parameter	Symbol	Value			Value			Value			Unit	
Horizontal display area	t_{hd}	1280			1408			1440			DCLK	
DCLK frequency	f_{clk}	Min.	Typ.	Max.	Min.	Typ.	Max.	Min.	Typ.	Max.	MHz	
		20.47	24.54	28.66	22.5	27	31.5	22.5	27	31.5		
1 Horizontal Line	t_h	1560			1716			1716			DCLK	
HSYNC pulse width	t_{npw}	Min.	1			1			1			
		Typ.	1			1			1			
		Max.	96			96			96			
HSYNC blanking	t_{hb}	237	252	268	237	252	268	237	252	268		
HSYNC front porch	t_{hfp}	43	28	12	71	56	40	39	24	8		

PAL

Parameter	Symbol	Value			Value			Unit	
Horizontal display area	t_{hd}	1408			1440			DCLK	
DCLK frequency	f_{clk}	Min.	Typ.	Max.	Min.	Typ.	Max.	MHz	
		22.5	27	31.5	22.5	27	31.5		
1 Horizontal Line	t_h	1728			1728			DCLK	
HSYNC pulse width	t_{npw}	Min.	1			1			
		Typ.	1			1			
		Max.	96			96			
HSYNC blanking	t_{hb}	237	252	268	237	252	268		
HSYNC front porch	t_{hfp}	83	68	52	51	36	20		

6.14.3. 3. CCIR

Parameter	Symbol	Mode(NTSC/PAL)	Unit	
Horizontal display area	t_{hd}	1440	DCLK	
DCLK frequency	f_{clk}	27	MHz	
1 Horizontal Line	t_h	1716	DCLK	
Internal HSYNC pulse width	t_{npw}	Min.		1
		Typ.		1
		Max.		-
HSYNC blanking	t_{hb}	268		

9. Standard Specification for Reliability

9.1 Standard Specification for Reliability of LCD Module

No.	Item	Description
01	High temperature operation	The sample should be allowed to stand at 70°C for 120 hours under driving condition and then returning it to normal temperature condition, and allowing it stand for 2 hours.
02	Low temperature operation	The sample should be allowed to stand at -20°C for 120 hours under driving condition and then returning it to normal temperature condition, and allowing it stand for 2 hours.
03	High temperature storage	The sample should be allowed to stand at 80°C for 240 hours under no-load condition, and then returning it to normal temperature condition, and allowing it stand for 2 hours.
04	Low temperature storage	The sample should be allowed to stand at -30°C for 240 hours under no-load condition, then returning it to normal temperature condition, and allowing it stand for 2 hours.
05	Moisture storage	The sample should be allowed to stand at 60°C,90%RH MAX for 240 hours under no-load condition, then taking it out and drying it at normal temperature for 2 hours.
06	Thermal shock storage	The sample should be allowed to stand the following 10 cycles : -30°C for 30 minutes → normal temperature for 5 minutes → +80°C for 30 minutes → normal temperature for 5 minutes, as one cycle.
07	Packing vibration	Frequency range : 10Hz ~ 55Hz Amplitude of vibration : 1.5mm Sweep time: 12 min X, Y, Z 2 hours for each direction.
08	Packing drop test	According to ASTM-D-5327.
09	Electrical Static Discharge	Air: ±4KV 150pF/330Ω 5 times
		Contact: ±2KV 150pF/330Ω 5 time

*Sample size for each test item is 3~5pcs

9.2 Testing Conditions and Inspection Criteria

For the final test, the testing sample must be stored at room temperature for 24 hours. After the tests listed in Table 9.2, standard specifications for reliability will be executed in order to ensure stability.

No.	Item	Test Model	In section Criteria
01	Current Consumption	Refer To Specification	The current consumption should conform to the product specification.
02	Contrast	Refer To Specification	After the tests have been executed, the contrast must be larger than half of its initial value prior to the tests.
03	Appearance	Visual inspection	Defect free.

9.3 MTBF

MTBF	Functions, performance, appearance, etc. shall be free from remarkable deterioration within 50,000 hours under ordinary operating and storage conditions room temperature ($25\pm 5^{\circ}\text{C}$), normal humidity ($50\pm 10\%$ RH), and in area not exposed to direct sun light.
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10. Specification of Quality Assurance

This standard of Quality Assurance confirms to the quality of LCD module products supplied by Orient Display.

10.1 Quality Test

Before delivering, the supplier should conduct the following tests to confirm the quality of products.

- Electrical-Optical Characteristics: According to the individual specification to test the product.
- Appearance Characteristics: According to the individual specification to test the product.
- Reliability Characteristics: According to the definition of reliability on the specification for testing products.

10.2 Delivery Test

Before delivering, the supplier should conduct the delivery test.

- Test method: According to MIL-STD105E.General Inspection Level II take a single time.
- The defects classify of AQL as following:
Major defect: AQL = 0.65
Minor defect: AQL = 2.5
Total defects: AQL = 2.5

10.3 Non-conforming Analysis & Deal With Manners

10.3.1 Non-conforming Analysis

- Purchaser should provide the data detail of non-conforming sample and the non-conforming.
- After receiving the data detail from purchaser, the analysis of non-conforming should be finished within two weeks.
- If the analysis can't be finished on time, supplier must notice purchaser 3 days in advance.

10.3.2 Disposition of non-conforming

- If any product defect be found during assembling, supplier must change the good for every defect after confirmation.
- Both supplier and customer should analyze the reason and discuss the disposition of non-conforming when the reason of nonconforming is not sure.

10.4 Agreement items

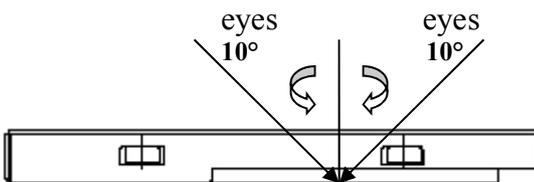
Both parties should negotiate together when the following problems happen.

- There is any problem of standard of quality assurance, and both sides should agree that it must be modified.
- There is any argument item which does not record in the standard of quality assurance.
- Any other special problem.

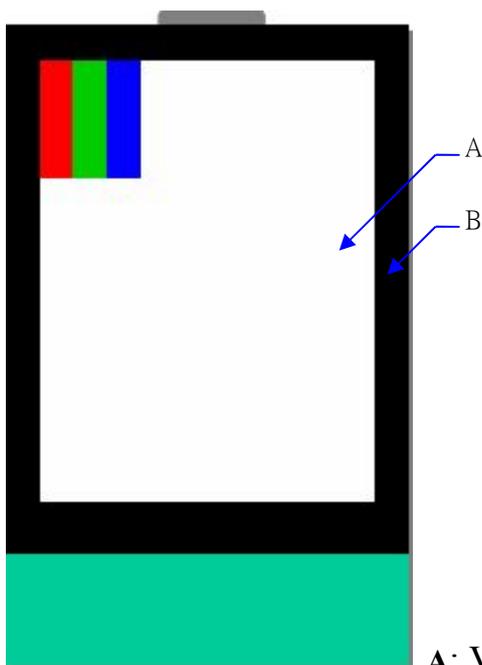
10.5 Standard of the Product Appearance Test

10.5.1 Manner of appearance test

- The test must be under 20W × 2 or 40W fluorescent light, and the distance of view must be at 30±5cm.
- When test the model of transmissive product must add the reflective plate.
- The test direction is base on around 10° of vertical line.
- Temperature: 25±5°C Humidity: 60±10%RH



- Definition of area:

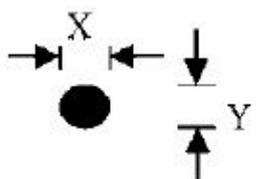
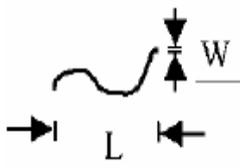


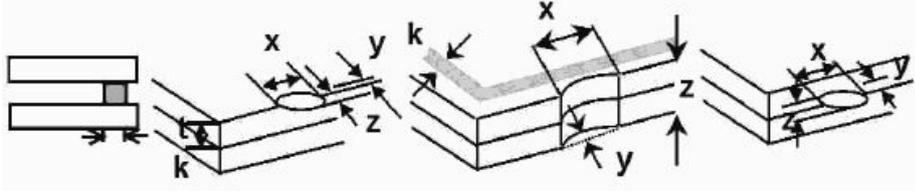
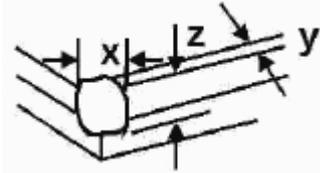
A: Viewing area B: Outside viewing area

10.5.2 Basic principle

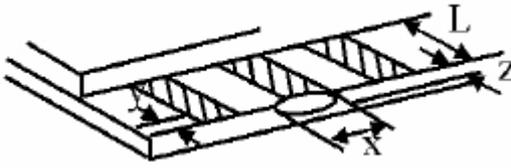
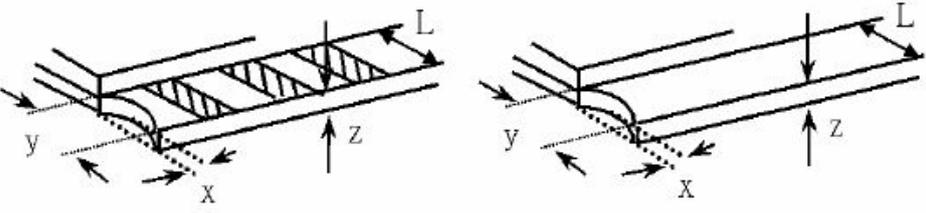
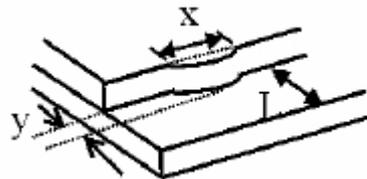
- When the standard cannot be described, AQL will be applied.
- The sample of the lowest acceptable quality level must be negotiated by both supplier and customer when any dispute happened.
- New item must be added on time when it is necessary.

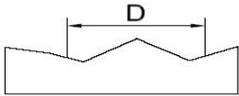
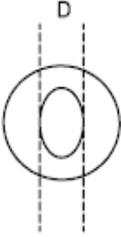
10.6 Inspection Specification

NO.	Item	Criterion	AQL												
01	Electrical Testing	1.1 Missing vertical, horizontal segment, segment contrast defect. 1.2 Missing character, dot or icon. 1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 LCD viewing angle defect. 1.7 Mixed product types. 1.8 Flicker	0.65												
02	Black or White spots or Bright spots or Color spots on LCD (Display only)	2.1 White and black or color spots on display $\cong 0.25\text{mm}$, no more than Five spots. 2.2 Densely spaced: No more than three spots within 3mm.	2.5												
03	LCD and Touch Panel black spots, white spots, contamination (non – display)	3.1 Round type: As following drawing $\Phi = (X+Y) / 2$  <table border="1" data-bbox="821 1131 1356 1377"> <thead> <tr> <th>Size(mm)</th> <th>Acceptable Q'ty</th> </tr> </thead> <tbody> <tr> <td>$\Phi \cong 0.10$</td> <td>Accept no dense</td> </tr> <tr> <td>$0.10 < \Phi \cong 0.20$</td> <td>2</td> </tr> <tr> <td>$0.20 < \Phi \cong 0.25$</td> <td>2</td> </tr> <tr> <td>$0.25 < \Phi \cong 0.30$</td> <td>1</td> </tr> <tr> <td>$0.30 < \Phi$</td> <td>0</td> </tr> </tbody> </table> <p>* Densely spaced: No more than two spots within 3mm.</p>	Size(mm)	Acceptable Q'ty	$\Phi \cong 0.10$	Accept no dense	$0.10 < \Phi \cong 0.20$	2	$0.20 < \Phi \cong 0.25$	2	$0.25 < \Phi \cong 0.30$	1	$0.30 < \Phi$	0	2.5
		Size(mm)	Acceptable Q'ty												
$\Phi \cong 0.10$	Accept no dense														
$0.10 < \Phi \cong 0.20$	2														
$0.20 < \Phi \cong 0.25$	2														
$0.25 < \Phi \cong 0.30$	1														
$0.30 < \Phi$	0														
3.2 Line type: (As following drawing)  <table border="1" data-bbox="726 1534 1356 1803"> <thead> <tr> <th>Length(mm)</th> <th>Width(mm)</th> <th>Acceptable Q'ty</th> </tr> </thead> <tbody> <tr> <td>---</td> <td>$W \cong 0.02$</td> <td>Accept no dense</td> </tr> <tr> <td>$L \cong 3.0$</td> <td>$0.02 < W \cong 0.05$</td> <td rowspan="2">2</td> </tr> <tr> <td>$L \cong 2.5$</td> <td>$0.03 < W \cong 0.08$</td> </tr> <tr> <td>---</td> <td>$0.08 < W$</td> <td>Rejection</td> </tr> </tbody> </table> <p>* Densely spaced: No more than two lines within 3mm.</p>	Length(mm)	Width(mm)	Acceptable Q'ty	---	$W \cong 0.02$	Accept no dense	$L \cong 3.0$	$0.02 < W \cong 0.05$	2	$L \cong 2.5$	$0.03 < W \cong 0.08$	---	$0.08 < W$	Rejection	2.5
Length(mm)	Width(mm)	Acceptable Q'ty													
---	$W \cong 0.02$	Accept no dense													
$L \cong 3.0$	$0.02 < W \cong 0.05$	2													
$L \cong 2.5$	$0.03 < W \cong 0.08$														
---	$0.08 < W$	Rejection													

NO.	Item	Criterion			AQL	
04	Polarizer bubbles	If bubbles are visible, judge using black spot specifications, not easy to find, must check in specify direction	Size Φ (mm)	Acceptable Q'ty	2.5	
			$\Phi \leq 0.20$	Accept no dense		
			$0.20 < \Phi \leq 0.50$	3		
			$0.50 < \Phi \leq 1.00$	2		
			$1.00 < \Phi$	0		
			Total Q'ty	3		
05	Scratches	Follow NO.3 -2 Line Type.				
06	Chipped glass	Symbols: x: Chip length y: Chip width z: Chip thickness k: Seal width t: Glass thickness a: LCD side length L: Electrode pad length 6.1 General glass chip: 6.1.1 Chip on panel surface and crack between panels:				2.5
			z: Chip thickness	y: Chip width	x: Chip length	
			$Z \leq 1/2t$	Not over viewing area	$x \leq 1/8a$	
			$1/2t < z \leq 2t$	Not exceed 1/3k	$x \leq 1/8a$	
			⊙ Unit: mm			
			⊙ If there are 2 or more chips, x is the total length of each chip			
6.1.2 Corner crack:				2.5		
z: Chip thickness	y: Chip width	x: Chip length				
$Z \leq 1/2t$	Not over viewing area	$x \leq 1/8a$				
$1/2t < z \leq 2t$	Not exceed 1/3k	$x \leq 1/8a$				
⊙ Unit: mm						
⊙ If there are 2 or more chips, x is the total length of each chip						

NO.	Item	Criterion	AQL
08	Cracked glass	The LCD with extensive crack is not acceptable.	2.5
09	Backlight elements	9.1 Illumination source flickers when lit. 9.2 Spots or scratches that appear when lit must be judged. Using LCD spot, lines and contamination standards. 9.3 Backlight doesn't light or color is wrong.	2.5 2.5 0.65
10	Bezel	Bezel must comply with product specifications.	2.5
11	PCB、COB	11.1 COB seal may not have pinholes larger than 0.2mm or contamination. 11.2 COB seal surface may not have pinholes through to the IC. 11.3 The height of the COB should not exceed the height indicated in the assembly diagram. 11.4 There may not be more than 2mm of sealant outside the seal area on PCB. And there should be no more than three places. 11.5 Parts on PCB must be the same as on the production characteristic chart, There should be no wrong parts, missing parts or excess parts. 11.6 The jumper on the PCB should conform to the product characteristic chart.	2.5 2.5 2.5 2.5 0.65 0.65
12	FPC	12.1 FPC terminal damage \leq 1/2 FPC terminal width and can not affect the function, we judge accept. 12.2 FPC alignment hole damage \leq 1/2 alignment area and can not affect the function, we judge accept.	2.5 2.5
13	Soldering	13.1 No cold solder joints, missing solder connections, oxidation or icicle. 13.2 No short circuits in components on PCB or FPC.	2.5 0.65

NO.	Item	Criterion	AQL																
07	Glass crack	<p>Symbols: x: Chip length y: Chip width z: Chip thickness k: Seal width t: Glass thickness a: LCD side length L: Electrode pad length</p> <p>7.2 Protrusion over terminal: 7.2.1 Chip on electrode pad:</p>  <table border="1" data-bbox="558 761 1236 907"> <tr> <td>y: Chip width</td> <td>x: Chip length</td> <td>z: Chip thickness</td> </tr> <tr> <td>$y \leq 0.5\text{mm}$</td> <td>$x \leq 1/8a$</td> <td>$0 < z \leq t$</td> </tr> </table> <p>7.2.2 Non-conductive portion:</p>  <table border="1" data-bbox="558 1276 1236 1422"> <tr> <td>y: Chip width</td> <td>x: Chip length</td> <td>z: Chip thickness</td> </tr> <tr> <td>$y \leq L$</td> <td>$x \leq 1/8a$</td> <td>$0 < z \leq t$</td> </tr> </table> <p>⊙ If there chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode terminal specifications. ⊙ If the product will be heat sealed by the customer, the alignment mark must not be damaged.</p> <p>7.2.3 Substrate protuberance and internal crack</p>  <table border="1" data-bbox="885 1747 1324 1892"> <tr> <td>y: width</td> <td>x: length</td> </tr> <tr> <td>$y \leq 1/3L$</td> <td>$X \leq a$</td> </tr> </table>	y: Chip width	x: Chip length	z: Chip thickness	$y \leq 0.5\text{mm}$	$x \leq 1/8a$	$0 < z \leq t$	y: Chip width	x: Chip length	z: Chip thickness	$y \leq L$	$x \leq 1/8a$	$0 < z \leq t$	y: width	x: length	$y \leq 1/3L$	$X \leq a$	2.5
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NO.	Item	Criterion	AQL										
15	Touch Panel(Fish eye、dent and bubble on film)	<table border="1" data-bbox="459 353 991 562"> <thead> <tr> <th>SIZE(mm)</th> <th>Acceptable Q'ty</th> </tr> </thead> <tbody> <tr> <td>$\Phi \leq 0.2$</td> <td>Accept no dense</td> </tr> <tr> <td>$0.2 < D \leq 0.4$</td> <td>5</td> </tr> <tr> <td>$0.4 < D \leq 0.5$</td> <td>2</td> </tr> <tr> <td>$0.5 < D$</td> <td>0</td> </tr> </tbody> </table>  	SIZE(mm)	Acceptable Q'ty	$\Phi \leq 0.2$	Accept no dense	$0.2 < D \leq 0.4$	5	$0.4 < D \leq 0.5$	2	$0.5 < D$	0	2.5
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$0.5 < D$	0												
16	Touch Panel Newton ring	Newton ring dimension $\leq 1/2$ touch panel area and not affect font and line distortion ($\leq 2.5\%$) , it is acceptable.	2.5										
17	Touch Panel Linearity	Less than 2.5% is acceptable.	2.5										
18	LCD Ripple	Touch the touch panel, cannot see the LCD ripple. Pen: R 1.0mm silicon rubber. Operation Force: 80g	2.5										
19	General appearance	19.1 Pin type must match type in specification sheet. 19.2 LCD pin loose or missing pins. 19.3 Product packaging must the same as specified on packaging specification sheet. 19.4 Product dimension and structure must conform to product specification sheet.	0.65 0.65 0.65 0.65										

11. Handling Precaution

11.1 Handling of LCM

- Avoid external shock.
- Don't apply excessive force on the surface.
- Liquid in LCD is hazardous substance, do not lick or swallow. When the liquid is attaching to your hand, skin, cloth, etc., wash it thoroughly and immediately.
- Don't operate it above the absolute maximum rating.
- Don't disassemble the LCM.
- The operators should wear protections whenever he/she comes into contact with the module. Never touch any of the conductive parts such as the LSI pads, the copper leads on the PCB and the interface terminals with any parts of the human body.
- The modules should be kept in antistatic bags or other containers resistant to static for storage.
- The module is coated with a film to protect the display surface, be careful when peeling off this protective film since static electricity may be generated.

11.2 Storage

- Store it in an ambient temperature of $25\pm 10^{\circ}\text{C}$, and in a relative humidity of $50\pm 10\%\text{RH}$. Don't expose to sunlight or fluorescent light.
- Store it in a clean environment, free from dust, active gas, and solvent.
- Store it in anti-static electricity container.
- Store it without any physical load.

11.3 Soldering

- Use only soldering irons with proper grounding and no leakage.
- Iron: no higher than $280\pm 10^{\circ}\text{C}$ and less than 3 sec during hand soldering.
- Rewiring: no more than 2 times.

12. Packing Method

----TBD